

## REMARKS

Applicants amended the specification and claims to correct several formalities.

Applicants respectfully request entering the enclosed amendment after allowance to improve the clarity and form of the specification.

In particular, the three paragraphs contained in the Comparative Example on page 11 included an inadvertent reversal of pads B and C. Referring to Table 1, on page 8, the unfilled pad “1B” had the high modulus and the filled pad “1C” had a lower modulus. Therefore, for consistency with Table 1, the comparative examples now refer to 1A, 1B and 1C and examples 1B and 1C refer to the proper comparative examples. Applicants respectfully submit that this enters no new matter.

In the claims, applicants amended the claims as follows:

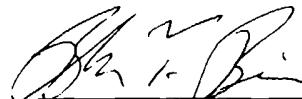
- 1) All claims, including dependent claims, refer back to their antecedent with the article “the” for consistency.
- 2) Claim 1 includes the language “useful” for in the preamble for clarity--although these pads are useful for polishing semiconductor wafers, they can have usefulness for polishing other substrates, such as, glass or nickel disks used for magnetic media.
- 3) Claims 2, 3, 5 to 10, 13 to 15, 26 and 27 now use the term wherein for consistency.
- 4) Claim 10 corrected the spelling of “devoid”.
- 5) Claim 13 includes “the polishing layer” comprises a thermoplastic polymer.
- 6) Claim 15 includes “the pad” comprises abrasive particles.
- 7) Claim 18 provides units for surface roughness and correctly refers to E' as a ratio.
- 8) Claims 20 and 21 delete articles for previously introduced terms and place the term micron in plural.

9) Claims 24 and 25 change "which" to that.

Applicants respectfully submit that these amendments enter no new matter and that the amended claims remain in proper form for allowance. If a telephone call would expedite matters, kindly call Applicants' attorney with the number provided below.

Respectfully submitted,

10/17/03  
Date



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I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Mail Stop RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below.

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